

2SK2762-01L,S

FUJI POWER MOSFET

N-CHANNEL SILICON POWER MOSFET

FAP-2S Series

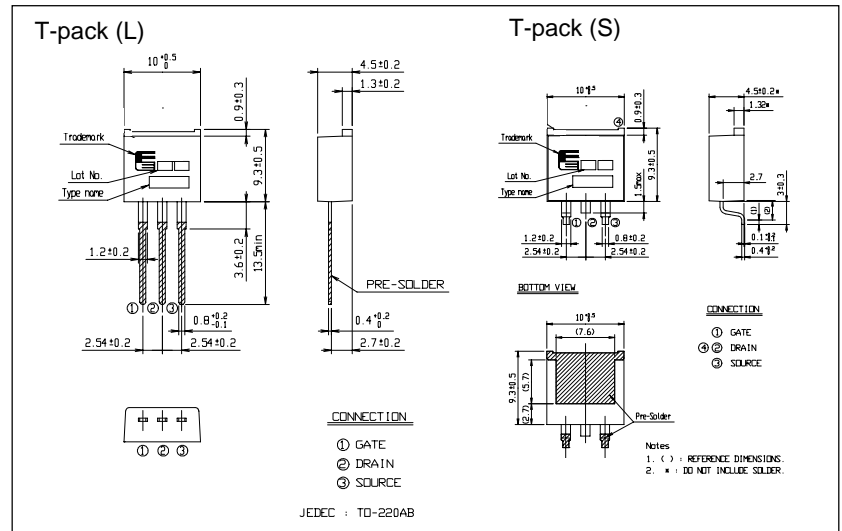
Outline Drawings

Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters



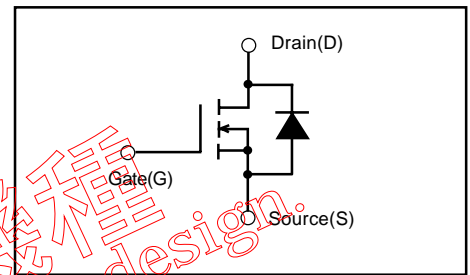
Maximum ratings and characteristic Absolute maximum ratings

(T_c=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	V _{DS}	800	V
Continuous drain current	I _D	±4	A
Pulsed drain current	I _{D(puls)}	±16	A
Gate-source voltage	V _{GS}	±35	V
Repetitive or non-repetitive	IAR*2	4	A
Maximum Avalanche Energy	EAS*1	254	mJ
Max. power dissipation	P _D	80	W
Operating and storage temperature range	T _{ch} T _{stg}	+150 -55 to +150	°C

*1 L=29.1mH, V_{CC}=80V *2 T_{ch}≥150°C

Equivalent circuit schematic



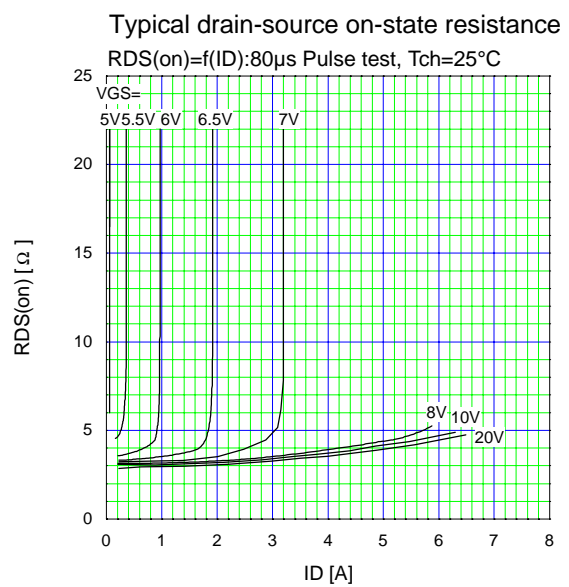
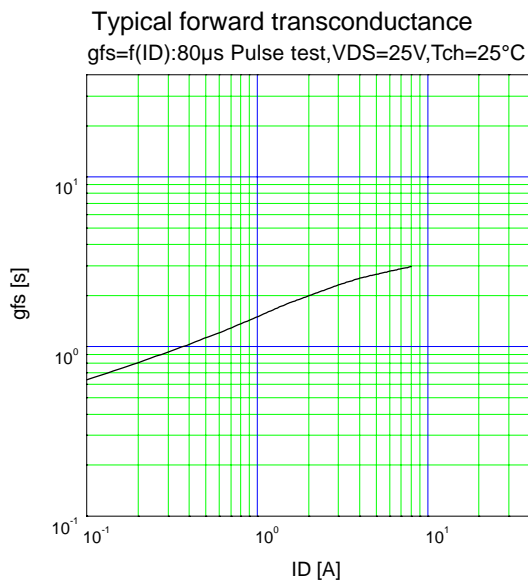
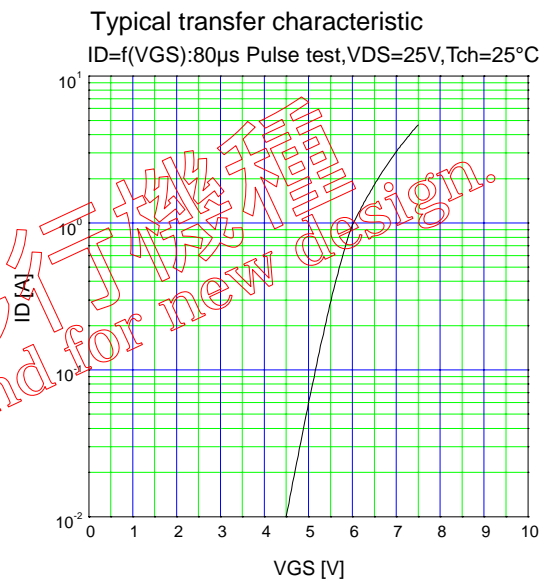
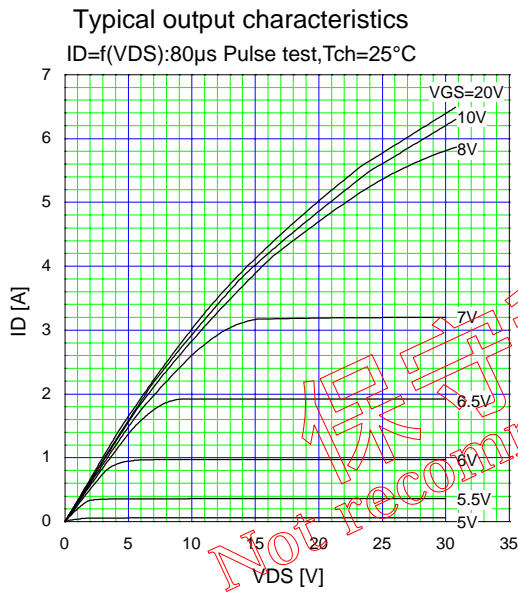
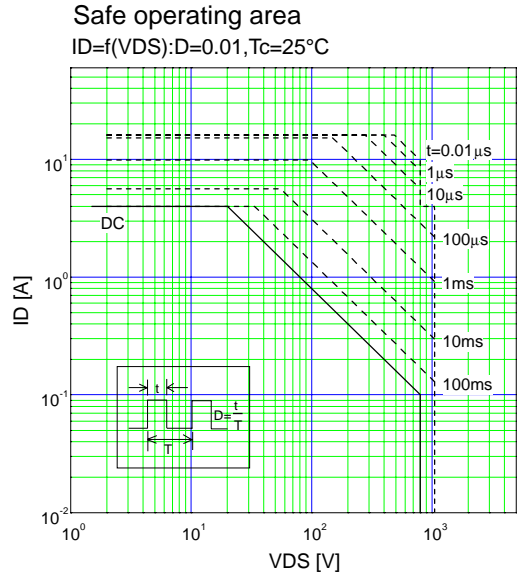
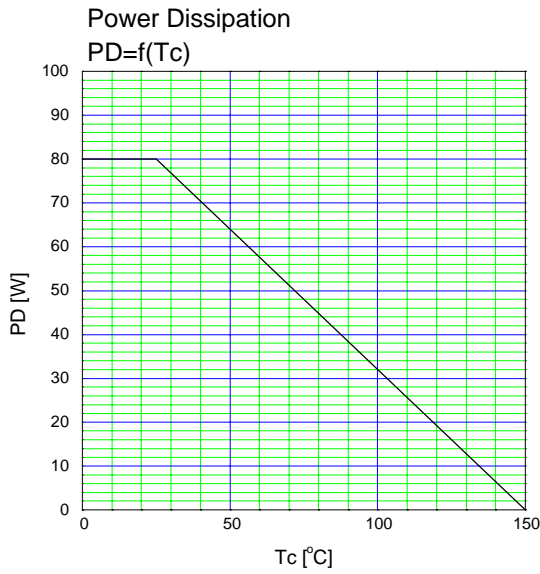
Electrical characteristics (T_c =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V _{(BR)DSS}	I _D =1mA V _{GS} =0V	800			V
Gate threshold voltage	V _{GS(th)}	I _D =1mA V _{DS} =V _{GS}	3.5	4.0	4.5	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =800V V _{GS} =0V		10	500	μA
		V _{GS} =0V		0.2	1.0	mA
Gate-source leakage current	I _{GSS}	V _{GS} =±35V V _{DS} =0V		10	100	nA
Drain-source on-state resistance	R _{DS(on)}	I _D =2.0A V _{GS} =10V		3.19	4.0	Ω
Forward transconductance	g _{fs}	I _D =2.0A V _{DS} =25V	1.0	2.0		S
Input capacitance	C _{iss}	V _{DS} =25V		450	680	pF
Output capacitance	C _{oss}	V _{GS} =0V		75	120	pF
Reverse transfer capacitance	C _{rss}	f=1MHz		40	60	pF
Turn-on time t _{on}	td(on)	V _{CC} =600V I _D =4A		20	30	ns
	t _r	V _{GS} =10V		45	70	
Turn-off time t _{off}	td(off)	R _{GS} =10 Ω		50	80	ns
	t _f			30	50	
Avalanche capability	I _{AV}	L=100 μH T _{ch} =25°C	4			A
Diode forward on-voltage	V _{SD}	I _F =2xI _{DR} V _{GS} =0V T _{ch} =25°C		1.0	1.5	V
Reverse recovery time	t _{rr}	I _F =I _{DR} V _{GS} =0V		700		ns
Reverse recovery charge	Q _{rr}	-di/dt=100A/μs T _{ch} =25°C		5.0		μC

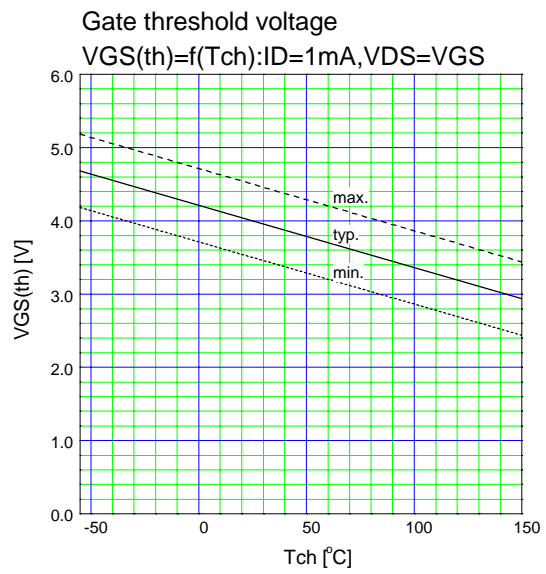
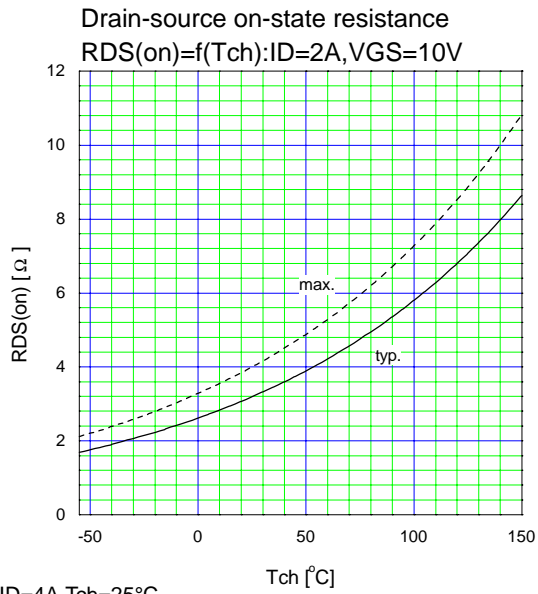
Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-c)}	channel to case			1.56	°C/W
	R _{th(ch-a)}	channel to ambient			75.0	°C/W

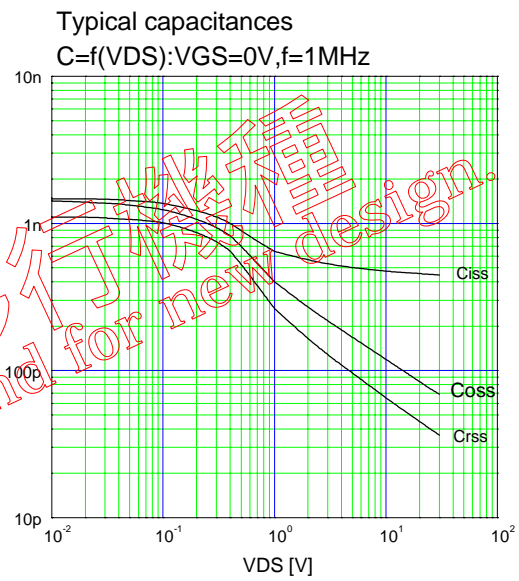
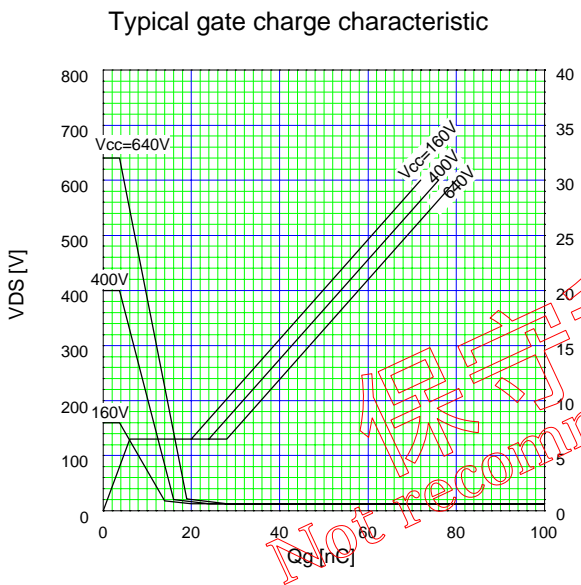
Characteristics



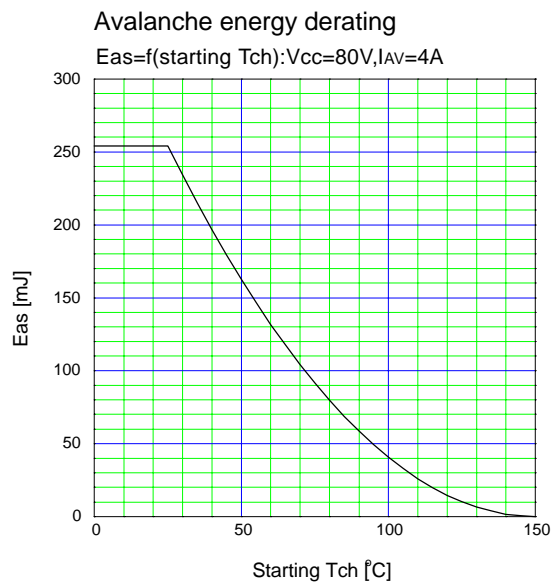
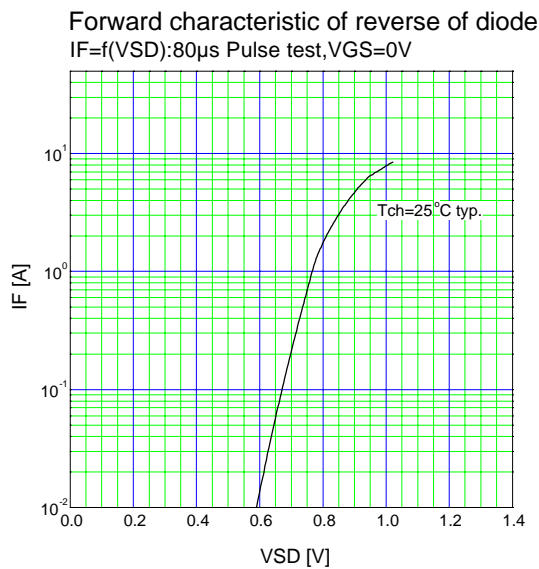
保守移行 技術情報
 Not recommend for new design.

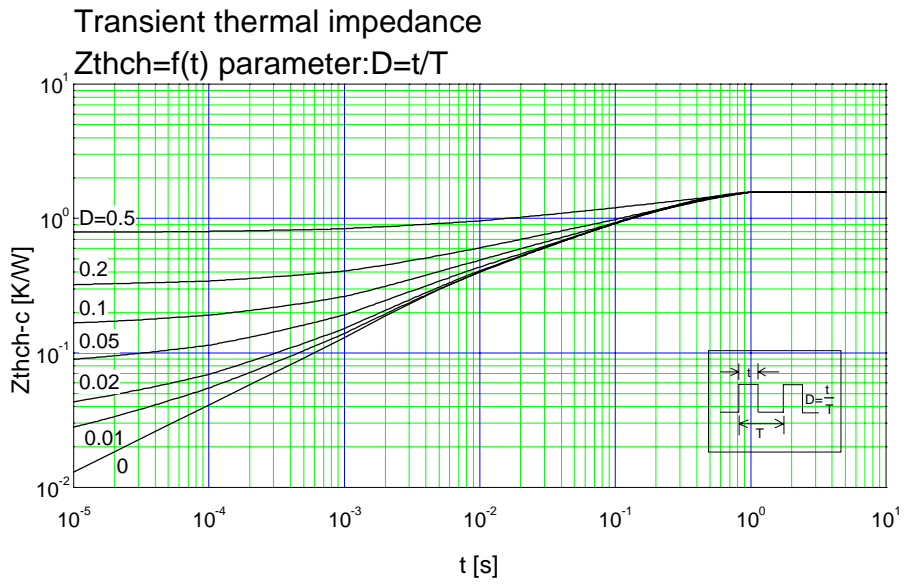


$V_{GS}=f(Q_g):I_D=4A, T_{ch}=25°C$



保持行機用
 NOT recommend for new design.





保守移行機種
Not recommend for new design.